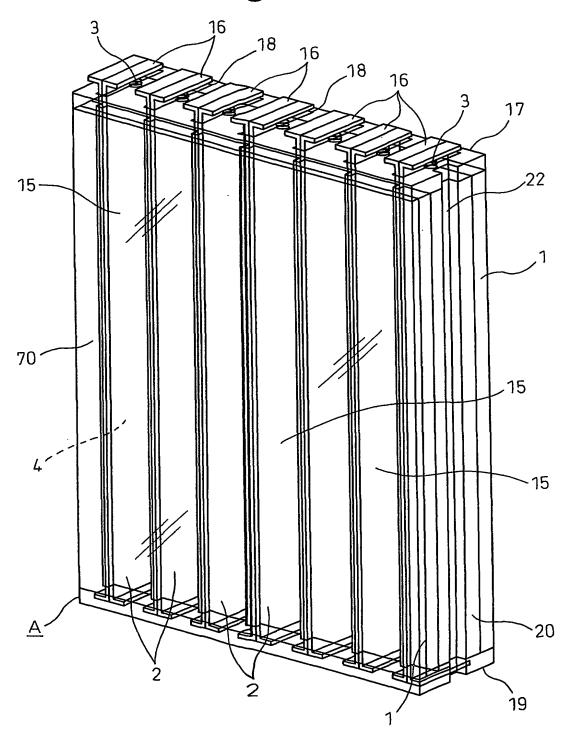
PCT/JP2004/013598

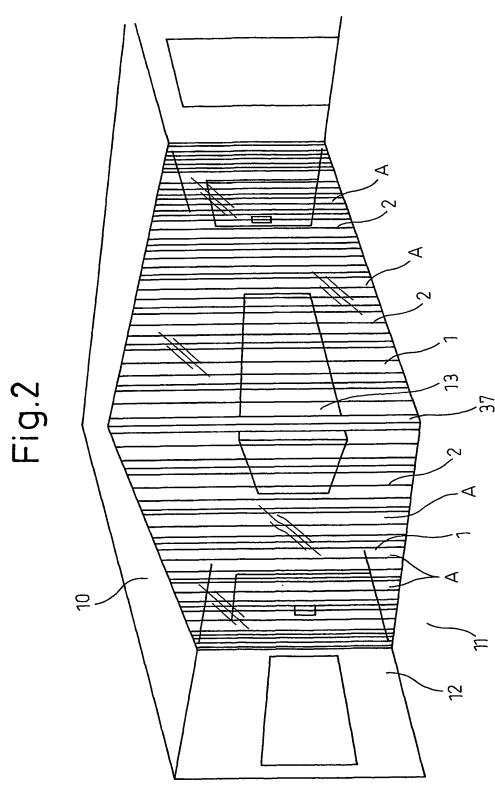
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Fig.1

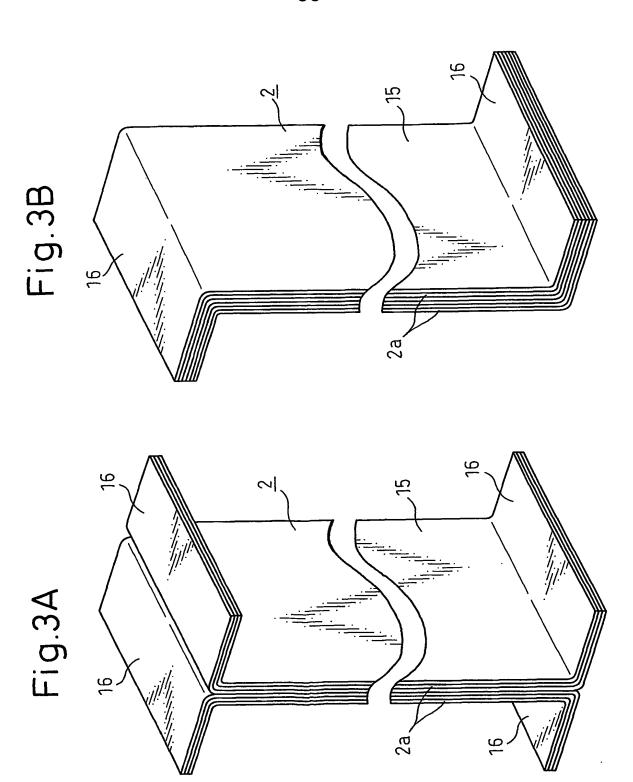
WO 2005/026462

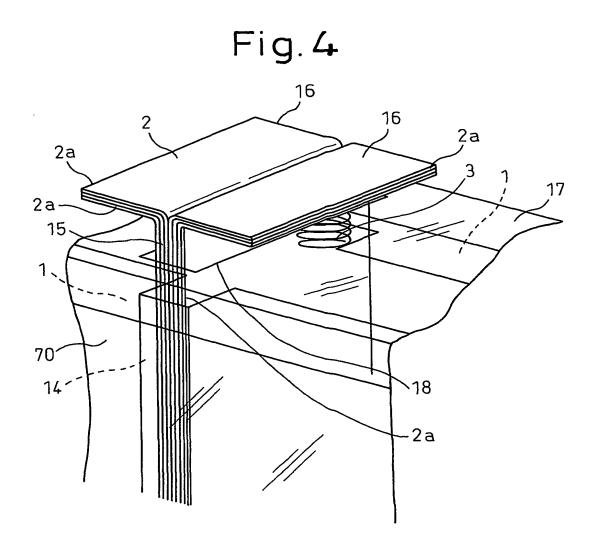






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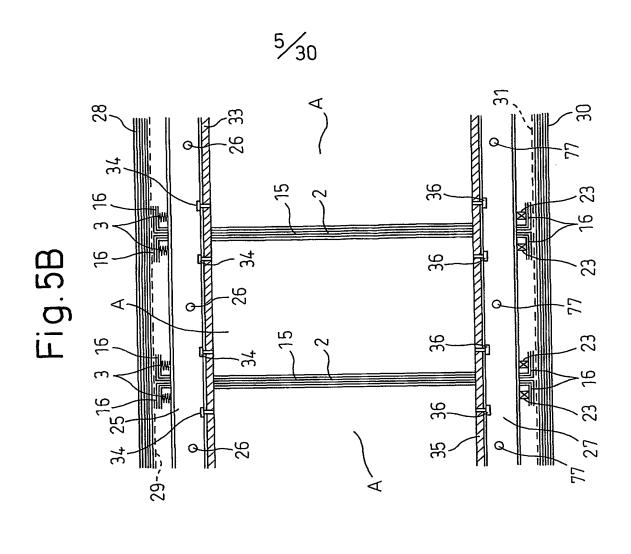


Fig. 5A

25 16 3 28 25

34 26 34

33 17 17 15

36 37 27 27

37 27 27

27 16 23 19 30



Fig.6A

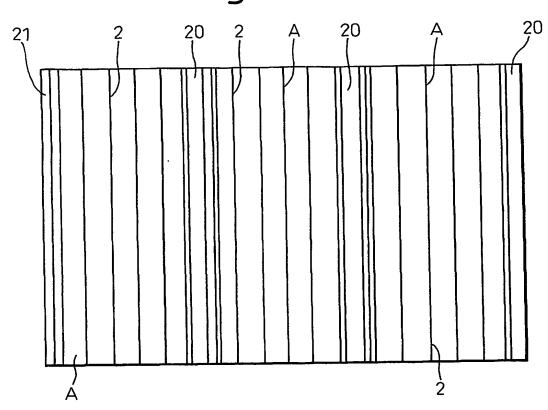


Fig.6B

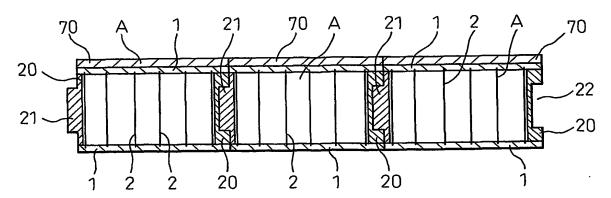
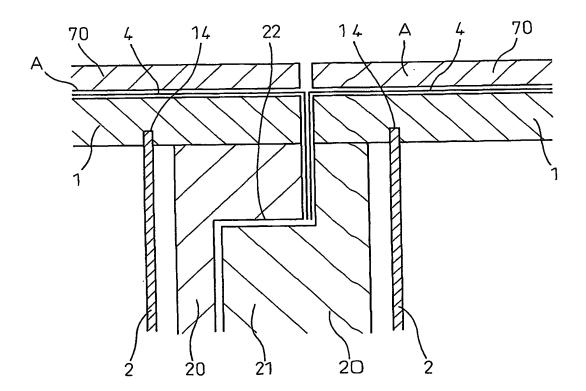
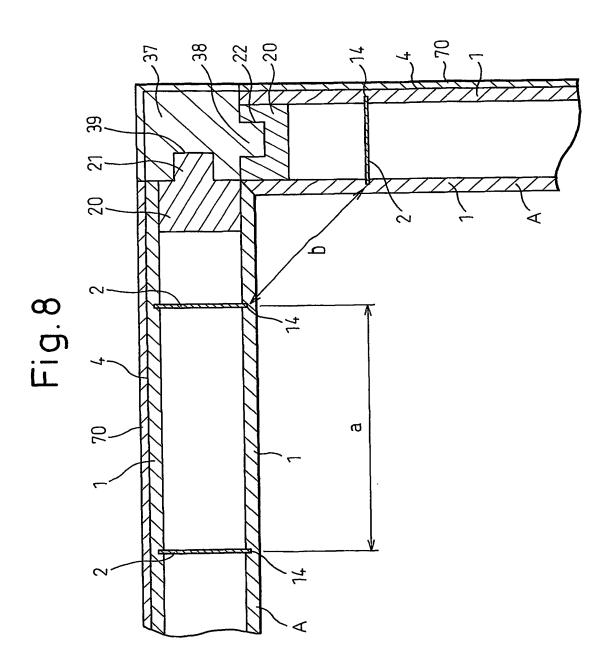
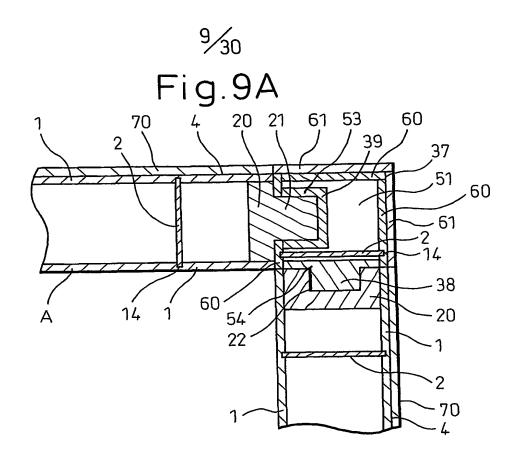


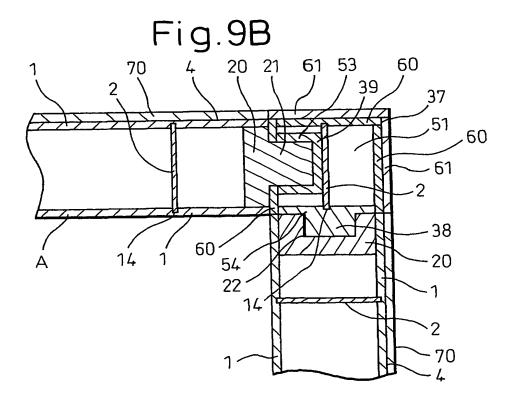
Fig.7

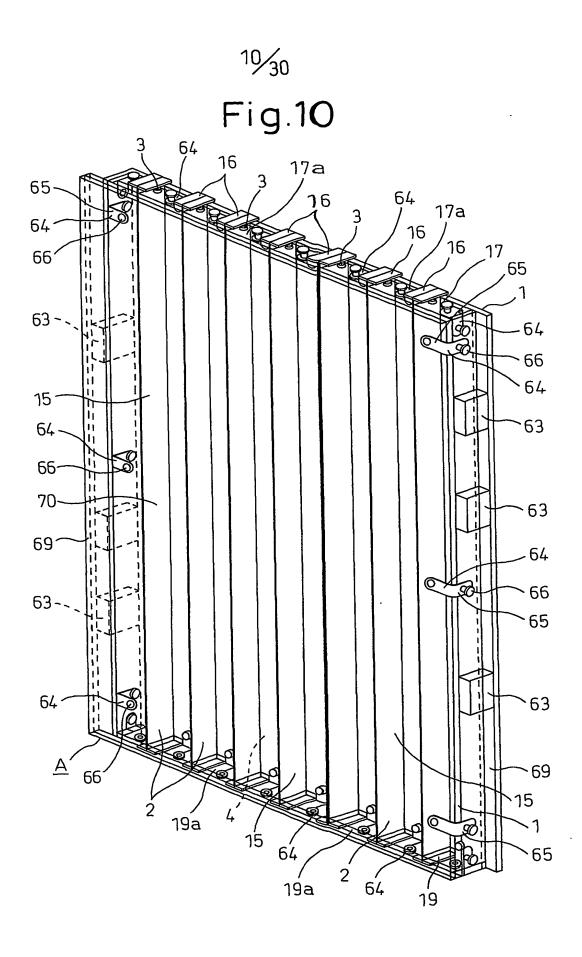




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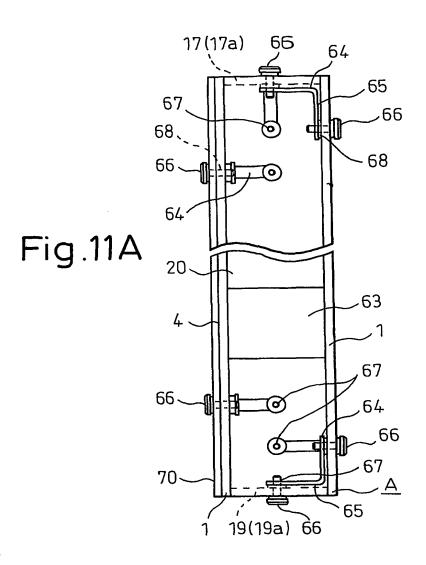
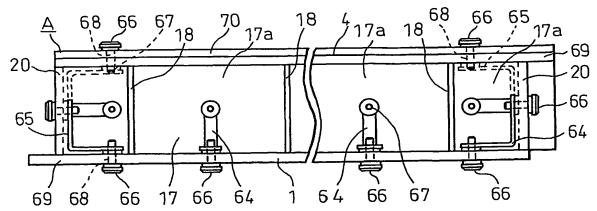


Fig.11B



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Fig.12A

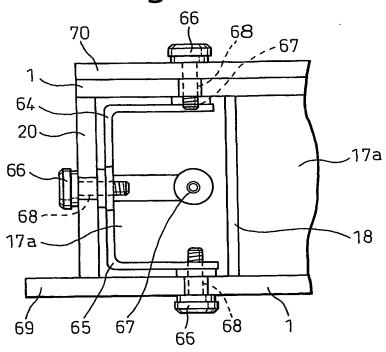
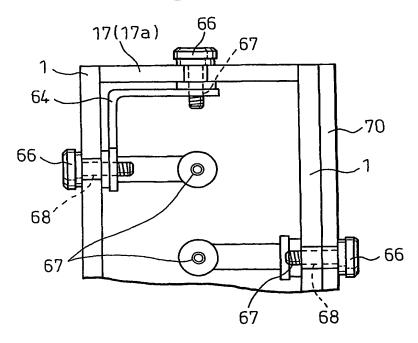


Fig.12B



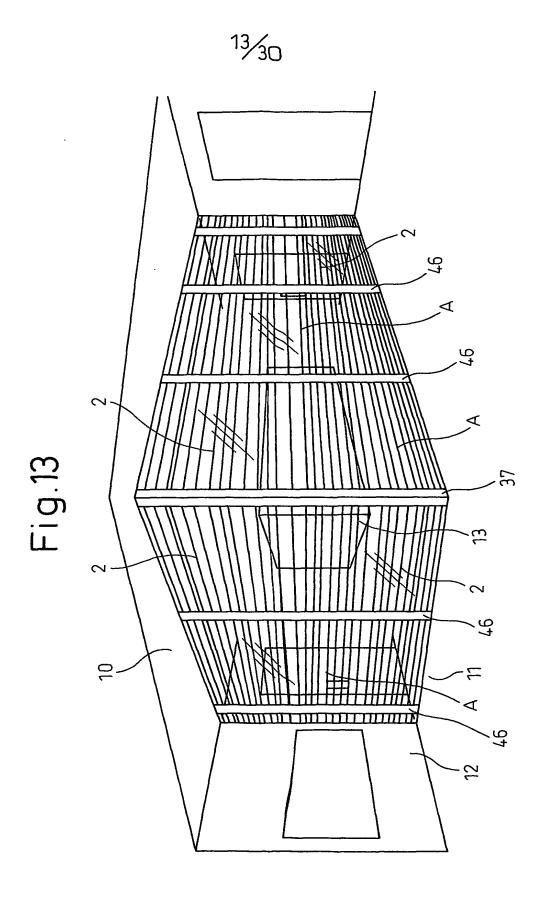


Fig.14A

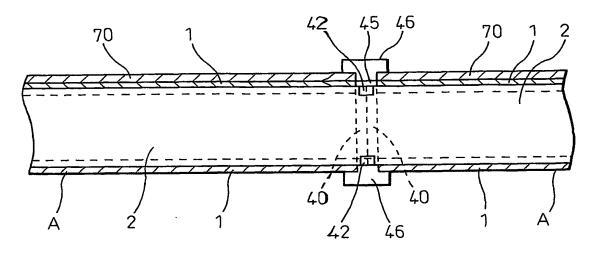
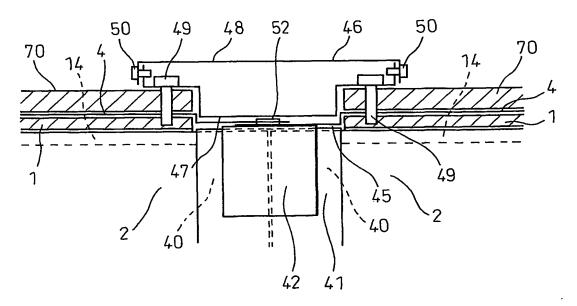


Fig.14B



¹⁵/30 12 Fig.15A

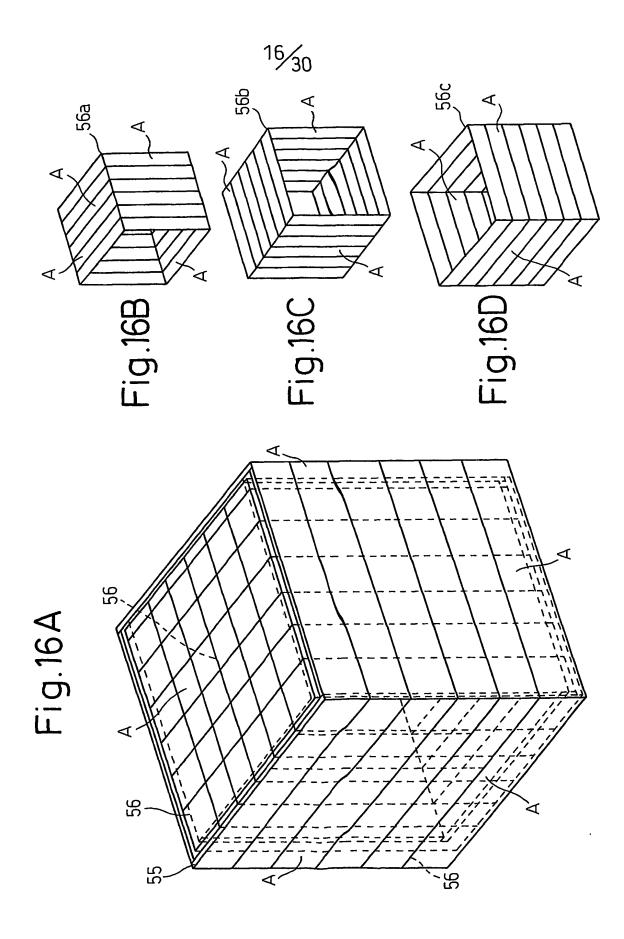


Fig.17

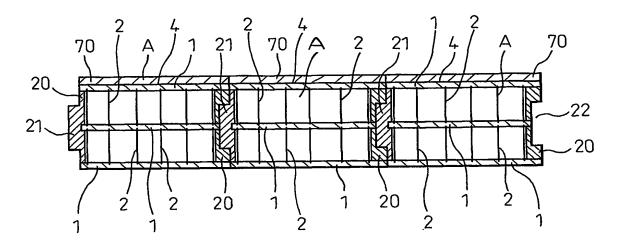


Fig.18

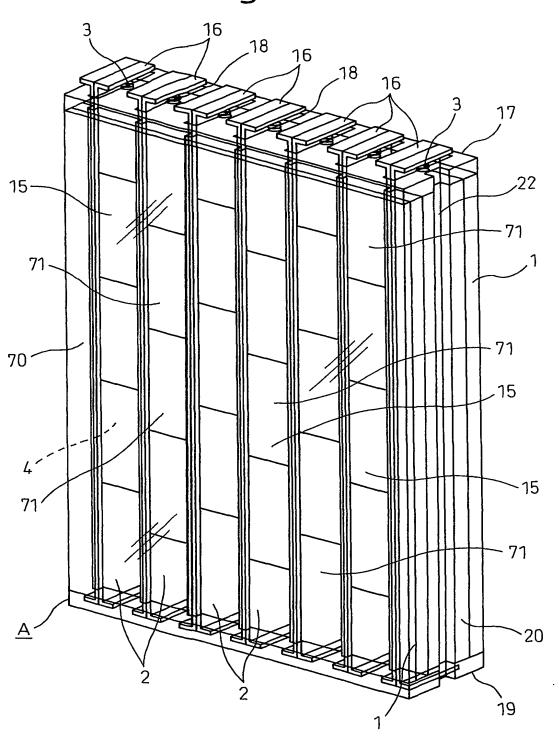
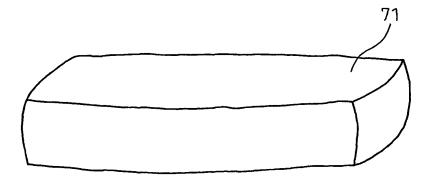
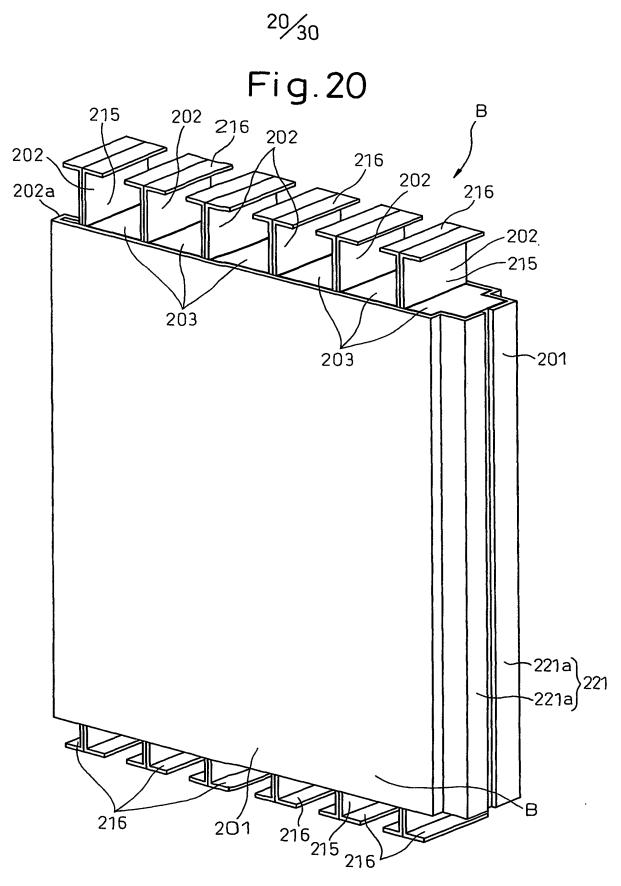


Fig.19

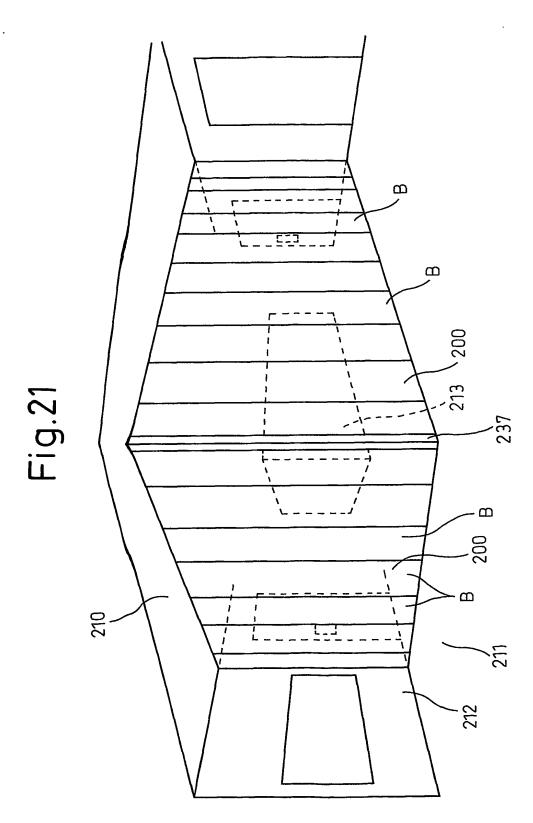


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Fig.22

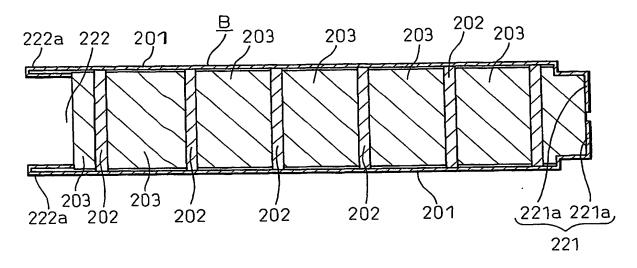
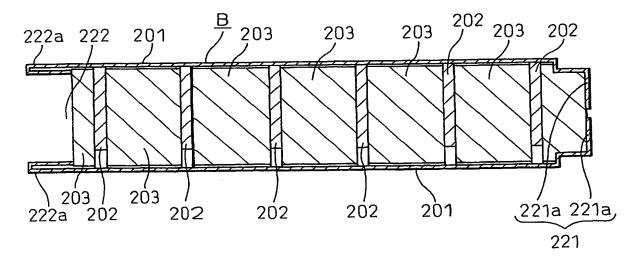


Fig.23



²³/₃₀ Fig. 24A

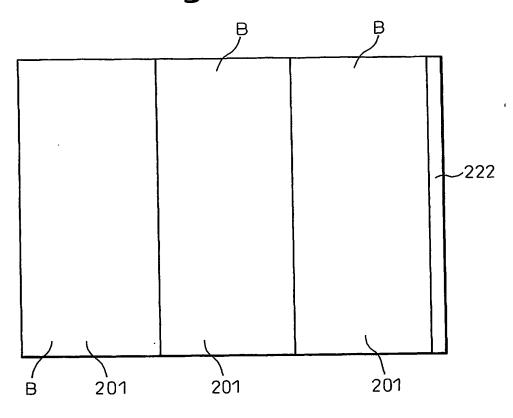


Fig.24B

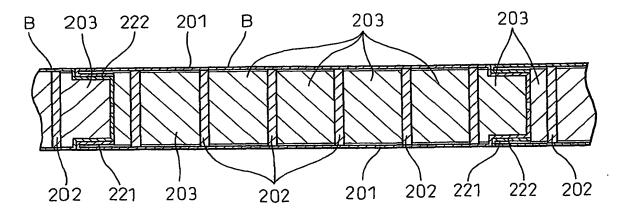
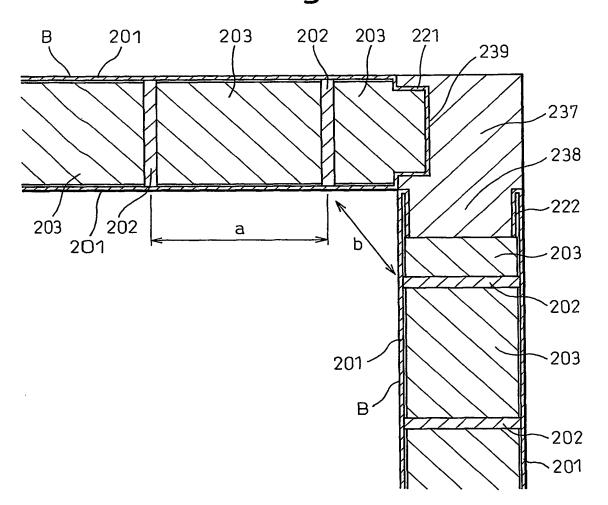
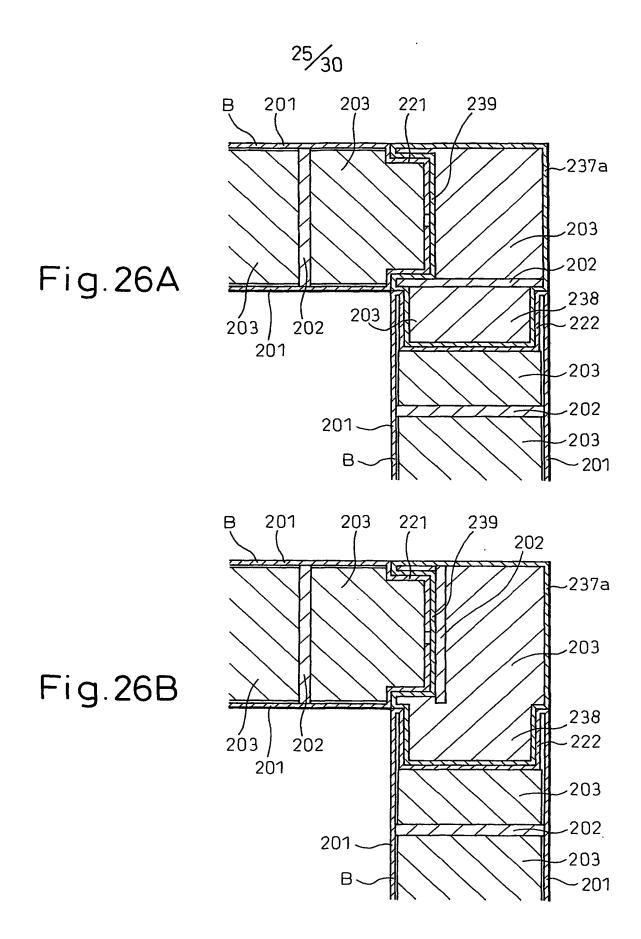


Fig. 25





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Fig.28A

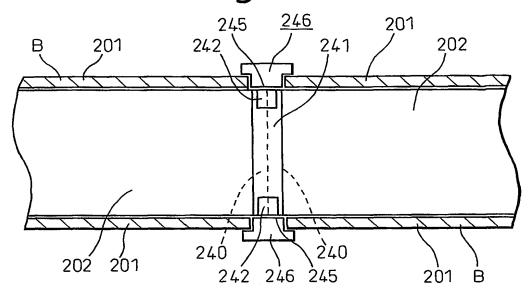


Fig.28B

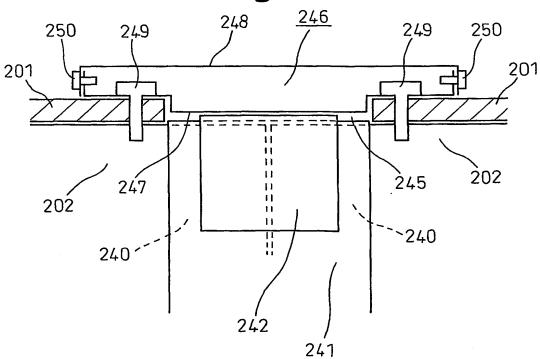




Fig.29A

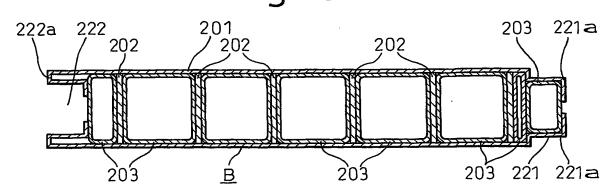
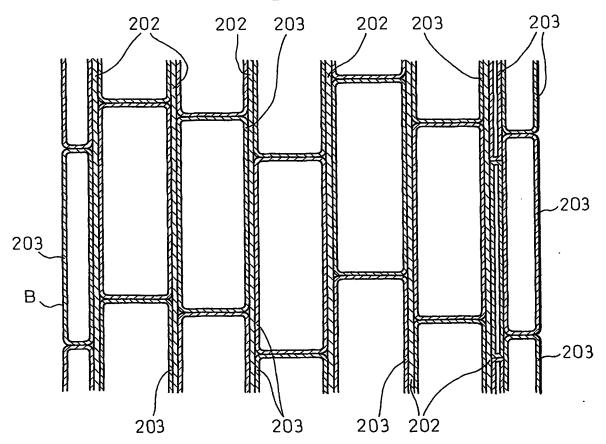
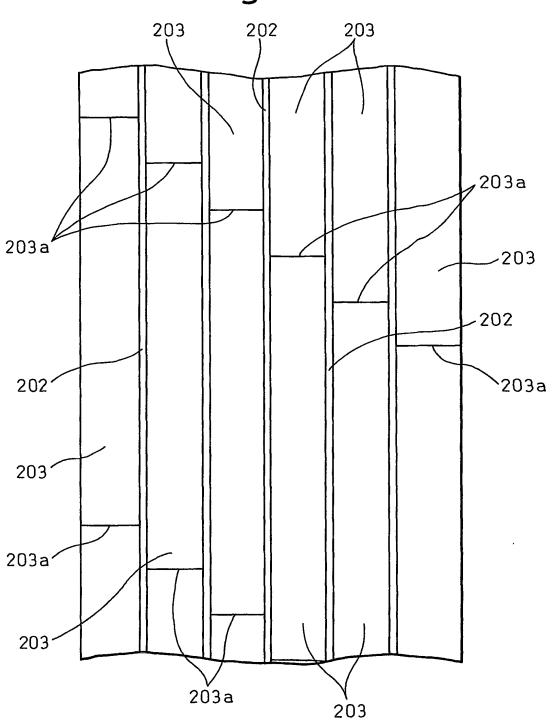


Fig.29B



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Fig.30



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